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Steppings





Specifications



| Specifications             |                                 |          |  |
|----------------------------|---------------------------------|----------|--|
| - Essentials               |                                 |          |  |
| Status                     | Launched                        |          |  |
| Launch Date                | Q1'12                           | 1<br>E   |  |
| Processor Number           | E5-2630                         | F        |  |
| Intel® Smart Cache         | 15 MB                           |          |  |
| Intel® QPI Speed           | 7.2 GT/s                        | Q        |  |
| # of QPI Links             | 2                               | er.      |  |
| Instruction Set            | 64-bit                          | E        |  |
| Instruction Set Extensions | AVX                             | 9        |  |
| Embedded Options Available | Q No                            | 3        |  |
| Lithography                | 32 nm                           |          |  |
| Scalability                | 2S Only                         |          |  |
| VID Voltage Range          | 0.60V-1.35V                     | P        |  |
| Recommended Customer Price | BOX: \$616.00<br>TRAY: \$612.00 | 91<br>91 |  |
| Datasheet                  | Link                            | SI 91    |  |
| Performance                |                                 |          |  |
|                            |                                 |          |  |

|      | Compare  |
|------|--|
| R    | elated Products                                  |
|      | Intel® Xeon® Processor<br>E5 Family              |
|      | Intel® Xeon® Processor<br>E5-2600 Product Family |
|      | Products formerly Sandy<br>Bridge EP             |
| Q    | uick Links                                       |
|      | Export Full Specifications                       |
|      | Search Distributors >                            |
| 23   | Software Downloads >                             |
|      | Support Overview >                               |
| 1700 | Search all of intel.com >                        |
| P    | CN/MDDS Information                              |
| S    | ROKY   |
|      | 19193: PCN   MDDS                                |
|      | 19839: PCN   MDDS                                |
| 5    | <b>ROH6</b><br>17893: PCN   MDDS                 |

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| # of Cores  |                 | 6                  |  |
|---|-----------------|--------------------|--|
| # of Threads  |                 | 12                 |  |
| Processor Base Frequency                                      |                 | 2.3 GHz            |  |
| Max Turbo Frequency   |                 | 2.8 GHz            |  |
| TDP   |                 | 95 W               |  |
| Memory Specifications   |                 |                    |  |
| Max Memory Size (dependent on memory type)                    |                 | 384 GB             |  |
| Memory Types  |                 | DDR3 800/1066/1333 |  |
| Max # of Memory Channels                                      |                 | 4                  |  |
| Max Memory Bandwidth  |                 | 42.6 GB/s          |  |
| ECC Memory Supported #  | Q               | Yes                |  |
| Expansion Options   |                 |                    |  |
| PCI Express Revision  |                 | 3.0                |  |
| Max # of PCI Express Lanes                                    |                 | 40                 |  |
| Package Specifications  |                 |                    |  |
| Max CPU Configuration   |                 | 2                  |  |
| TCASE   |                 | 77.4°C             |  |
| Package Size  | 52.5mm x 45.0mm |                    |  |
| Sockets Supported   | FCLGA2011       |                    |  |
| Low Halogen Options Available                                 |                 | See MDDS           |  |
| Advanced Technologies   |                 |                    |  |
| Intel® Turbo Boost Technology *                               |                 | 1.0                |  |
| Intel® vPro Technology #                                      | Q               | Yes                |  |
| Intel® Hyper-Threading Technology *                           | Q               | Yes                |  |
| Intel® Virtualization Technology (VT-x) *                     |                 | Yes                |  |
| Intel® Virtualization Technology for Directed I/O<br>(VT-d) * | Q               | Yes                |  |
| Intel® VT-x with Extended Page Tables (EPT) #                 | Q               | Yes                |  |
| Intel® 64 *   | Q               | Yes                |  |
| Idle States   |                 | Yes                |  |
| Enhanced Intel SpeedStep® Technology                          | Q               | Yes                |  |
| Intel® Demand Based Switching                                 | Q               | Yes                |  |
| Thermal Monitoring Technologies                               |                 | Yes                |  |
| Intel® Flex Memory Access                                     |                 | No                 |  |
| Intel® Identity Protection Technology #                       |                 | No                 |  |
| Intel® Data Protection Technology                             |                 |                    |  |
| AES New Instructions  | Q               | Yes                |  |
| Intel® Platform Protection Technology                         |                 |                    |  |
|   |                 |                    |  |

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Refer to Datasheet for formal definitions of product properties and features.

/www/us/en/processors/processor-numbers.html for details,

"Announced" SKUs are not yet available. Please refer to the Launch Date for market availability.

Trusted Execution Technology \*

Execute Disable Bit #

Some products can support AES New Instructions with a Processor Configuration update, in particular, i7-2630QM/i7-2635QM, i7-2670QM/i7-2675QM, i5-2430M/i5-2435M, i5-2410M/i5-2415M. Please contact OEM for the BIOS that includes the latest Processor configuration update. # This feature may not be available on all computing systems. Please check with the system vendor to determine if your system delivers this feature, or reference the system specifications (motherboard,

processor, chipset, power supply, HDD, graphics controller, memory, BIOS, drivers, virtual machine monitor-VMM, platform software, and/or operating system) for feature compatibility. Functionality, performance, and other benefits of this feature may vary depending on system configuration.

"Conflict free" and "conflict-free" means "DRC conflict free", which is defined by the U.S. Securities and Exchange Commission rules to mean products that do not contain conflict minerals (tin, tantalum, tungsten and/or gold) that directly or indirectly finance or benefit armed groups in the Democratic Republic of the Congo (DRC) or adjoining countries. Intel also uses the term "conflict-free" in a broader sense to refer to suppliers, supply chains, smelters and refiners whose sources of conflict minerals do not finance conflict in the DRC or adjoining countries. Intel processors manufactured before January 1, 2013 are not confirmed conflict free. The conflict free designation refers only to product manufactured after that date. For Intel Boxed Processors, the conflict free designation refers to the processor only, not to any additional included accessories, such as heatsinks/coolers.

See http://www.intel.com/content/www/us/en/architecture-and-technology/hyper-threading-technology.html?wapkw=hyper+threading for more information including details on which processors support Intel® HT Technology. Max Turbo Frequency refers to the maximum single-core processor frequency that can be achieved with Intel® Turbo Boost Technology. See www.intel.com/technology/turboboost/ for more information.

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Low Halogen: Applies only to brominated and chlorinated flame retardants (BFRs/CFRs) and PVC in the final product. Intel components as well as purchased components on the finished assembly meet JS-709 requirements, and the PCB / substrate meet IEC 61249-2-21 requirements. The replacement of halogenated flame retardants and/or PVC may not be better for the environment.

For benchmarking data see http://www.intel.com/performance.

Intel processor numbers are not a measure of performance. Processor numbers differentiate features within each processor family, not across different processor families. See http://www.intel.com/content

Processors that support 64-bit computing on Intel® architecture require an Intel 64 architecture-enabled BIOS.

System and Maximum TDP is based on worst case scenarios. Actual TDP may be lower if not all I/Os for chipsets are used.

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